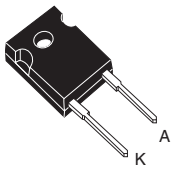
STTH2006

Turbo 2 ultrafast high voltage rectifier

Main product characteristics

$I_{F(AV)}$	20 A
V_{RRM}	600 V
T_j	175° C
V_F (typ)	1.0 V
t_{rr} (max)	50 ns



DO-247
STTH2006W

Features and benefits

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching and conduction losses

Description

The STTH2006 uses ST Turbo 2 600 V technology and is especially suited for use in switching power supplies, and industrial applications, such as rectification and continuous mode PFC boost diode.

Order Codes

Part Number	Marking
STTH2006W	STTH2006W

Table 1. Absolute Ratings (limiting values)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		600	V
$I_{F(RMS)}$	RMS forward voltage		50	A
$I_{F(AV)}$	Average forward current	T_c = 120° C δ = 0.5	20	A
I_{FSM}	Surge non repetitive forward current	t_p = 10 ms sinusoidal	160	A
T_{stg}	Storage temperature range		-65 to + 175	° C
T_j	Maximum operating junction temperature		175	° C

1 Characteristics

Table 2. Thermal resistance

Symbol	Parameter	Value (max).	Unit
$R_{th(j-c)}$	Junction to case	1.1	°C/W

Table 3. Static electrical characteristic

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
I_R (1)	Reverse leakage current	T_j = 25° C	$V_R = V_{RRM}$			25	µA
		T_j = 150° C			80	800	
V_F (2)	Forward voltage drop	T_j = 25° C	I_F = 20 A			1.75	V
		T_j = 150° C			1.00	1.35	

1. Pulse test: t_p = 5 ms, δ < 2%
2. Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation:
$P = 1.13 \times I_{F(AV)} + 0.011\ I_F{}^2{}_{(RMS)}$

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
t_{rr}	Reverse recovery time	T_j = 25° C	I_F = 0.5 A I_{rr} = 0.25 A I_R =1 A			50	ns
			I_F = 1 A dI_F/dt = -50 A/µs V_R =30 V		50	70	
I_{RM}	Reverse recovery current	T_j = 125° C	I_F = 30 A V_R = 400 V dI_F/dt = -100 A/µs		8	11	A
t_{fr}	Forward recovery time	T_j = 25 °C	I_F = 30 A dI_F/dt = 100 A/µs $V_{FR} = 1.1 \times V_{Fmax}$			500	ns
V_{FP}	Forward recovery voltage	T_j = 25° C	I_F = 30 A dI_F/dt = 100 A/µs $V_{FR} = 1.1 \times V_{Fmax}$		2.5		V

Figure 1. Conduction losses versus average forward current

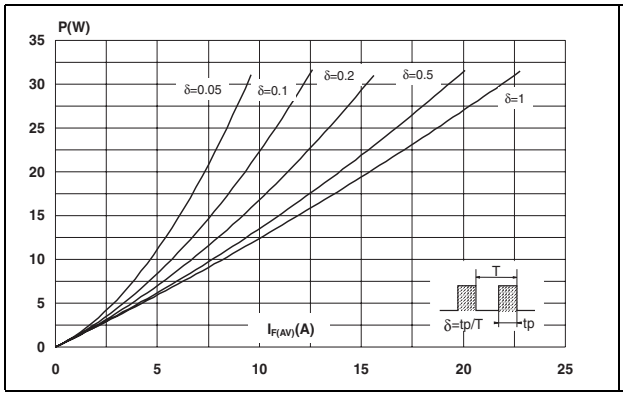


Figure 2. Forward voltage drop versus forward current

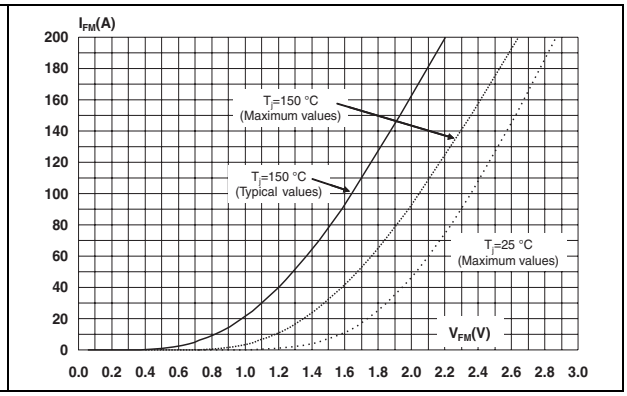


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

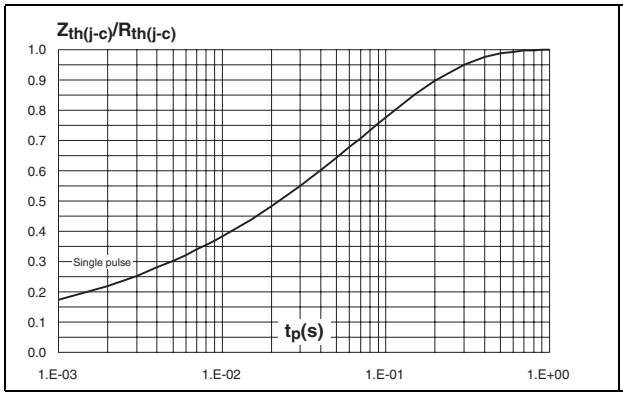


Figure 4. Peak reverse recovery current versus dI_F/dt (typical values)

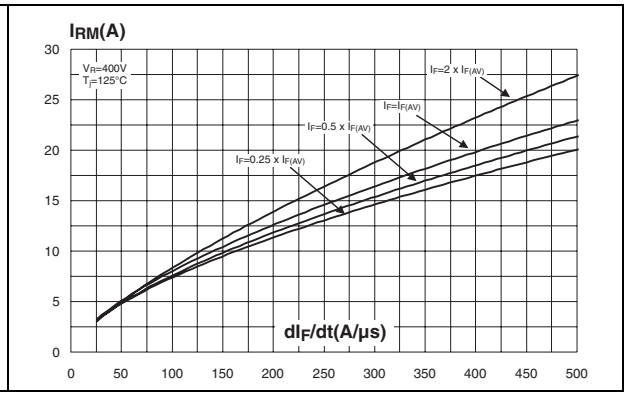


Figure 5. Reverse recovery time versus dI_F/dt (typical values)

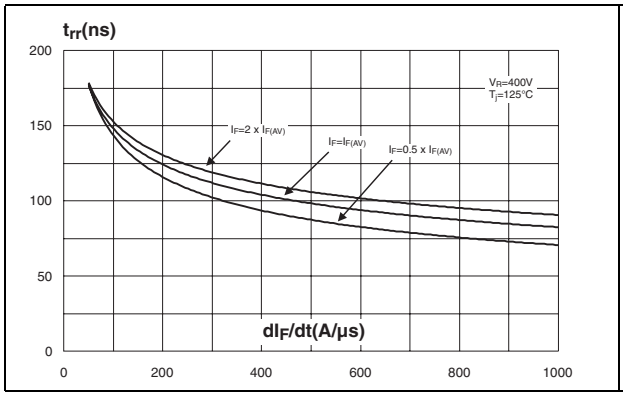


Figure 6. Reverse recovery charges versus dI_F/dt (typical values)

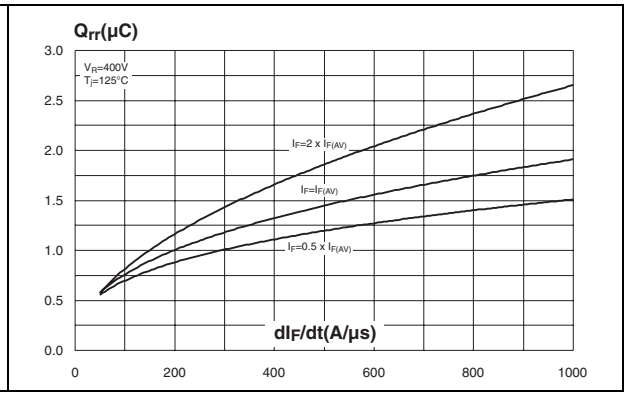


Figure 7. Softness factor versus dI_F/dt (typical values)

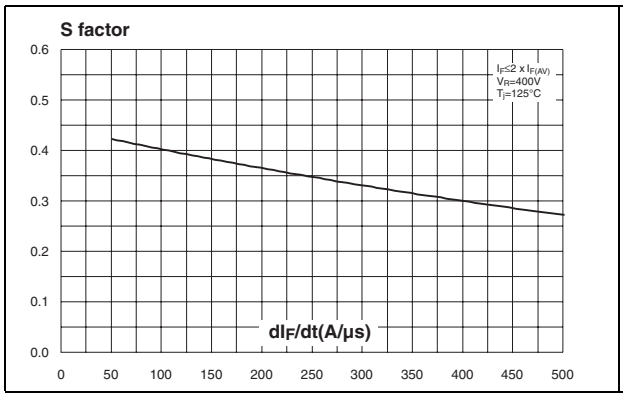


Figure 8. Relative variations of dynamic parameters versus junction temperature

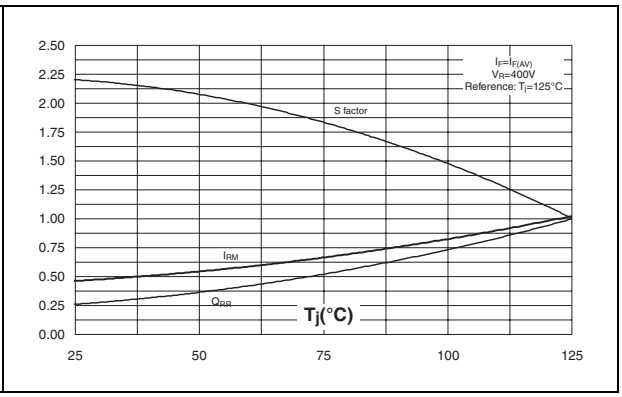


Figure 9. Transient peak forward voltage versus dI_F/dt (typical values)

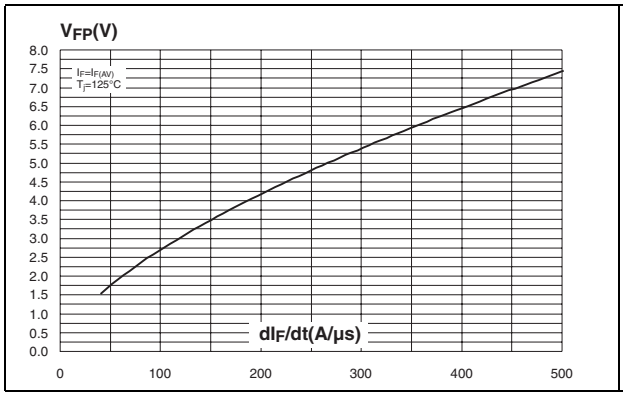


Figure 10. Forward recovery time versus dI_F/dt (typical values)

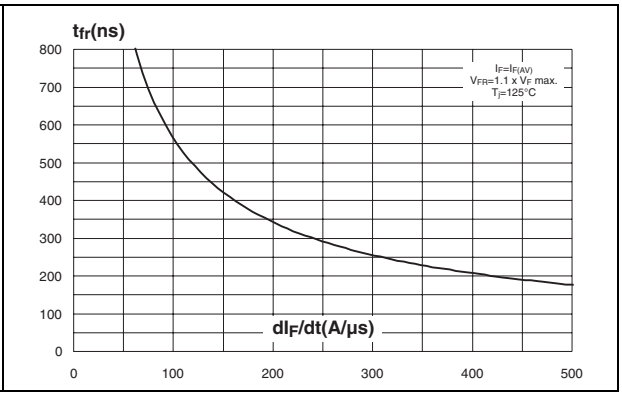
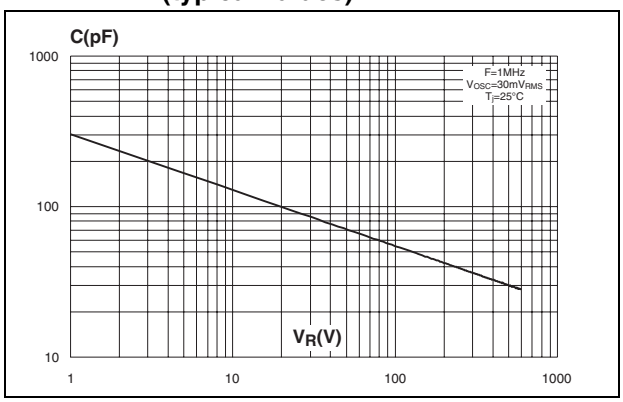


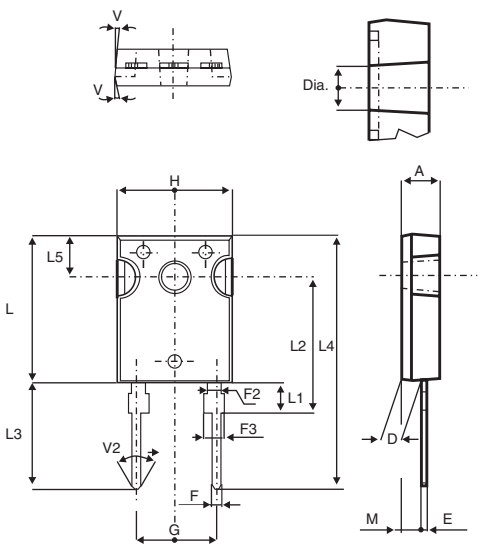
Figure 11. Junction capacitance versus reverse voltage applied (typical values)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 Nm
- Maximum torque value: 0.70 Nm

Table 5. DO-247 Package dimensions



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.85		5.15	0.191		0.203
D	2.20		2.60	0.086		0.102
E	0.40		0.80	0.015		0.031
F	1.00		1.40	0.039		0.055
F2		2.00			0.078	
F3	2.00		2.40	0.078		0.094
G		10.90			0.429	
H	15.45		15.75	0.608		0.620
L	19.85		20.15	0.781		0.793
L1	3.70		4.30	0.145		0.169
L2		18.50			0.728	
L3	14.20		14.80	0.559		0.582
L4		34.60			1.362	
L5		5.50			0.216	
M	2.00		3.00	0.078		0.118
V		5°			5°	
V2		60°			60°	
Dia.	3.55		3.65	0.139		0.143

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

3 Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTH2006W	STTH2006W	DO-247	4.40 g	30	Tube

4 Revision history

Date	Revision	Changes
13-Jul-2006	1	Initial release.

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